# ADT4CH60E/80E

# 3 Quadrants High temperature Triacs

## **General Description**

High current density due to mesa technology, guaranteed maximum junction temperature 150° C. The ADT4CH triac series is suitable for general purpose AC switching. They can beused as an ON/OFF function in applications such as static relays, heating regulation, Rectifier-fed DC inductive loads e.g.DC motors and solenoids, motor speed controllers. The heatsink can be reduced, compared to traditional triacs, according to the high performance at given junction temperatures.

#### Features

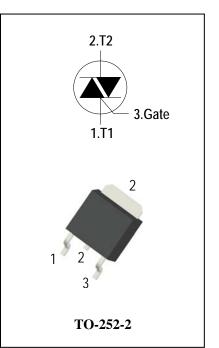
- ◆ Repetitive Peak Off-State Voltage: 600V/800V
- ◆ R.M.S On-State Current ( IT(RMS)= 4A )
- ◆ High Commutation dv/dt
- High junction temperature operating capability
- ◆ These Devices are Pb-Free and are RoHS Compliant

Symbol	Items	Conditions		Ratings	Unit
V <sub>DRM</sub>	Departitive Deals Off State Valtage	Ti - 25°C	ADT4CH60E	600	V
V <sub>RRM</sub>	Repetitive Peak Off-State Voltage	Tj = 25°C	ADT4CH80E	800	V
I <sub>T(RMS)</sub>	R.M.S On-State Current	T <sub>c</sub> = 130 °C		4	А
I <sub>TSM</sub>	Surge On-State Current	tp=20ms(50Hz)/tp=16.7ms(60Hz)		40/42	А
l <sup>2</sup> t	I <sup>2</sup> t for fusing	tp=10ms		8	A <sup>2</sup> s
ما ا ما	Critical rate of rise of on-state F = 120 Hz Tj = 150°C			50	A/µs
dl/dt	current	$I_{G}$ = 2 x $I_{GT}$ , tr $\leq$ 100 ns			
I <sub>GM</sub>	Peak Gate Current	tp = 20 μs Tj = 150°C		4	А
$P_{G(AV)}$	Average Gate Power Dissipation(Tj=150°C)			1	W
$P_{GM}$	Peak Gate Power Dissipation(tp=20us,Tj=150°C)			5	W
Tj	Operating Junction Temperature			- 40 ~ 150	°C
T <sub>STG</sub>	Storage Temperature			- 40 ~ 150	°C

## **Absolute Maximum Ratings**



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## Electrical Characteristics (Tj = 25°C unless otherwise specified )

Symbol	Items		Conditions		ADT4CH60E/80E		Unit	
					S	Blank	В	
I <sub>DRM</sub>	Peak Forward Reverse Blocking		V <sub>DRM</sub> = V <sub>RRM,</sub> Tj = 25°C		5		uA	
I <sub>RRM</sub>	Current		V <sub>DRM</sub> = V <sub>RRM,</sub> Tj = 150°C	Max.	1.75			mA
V <sub>TM</sub>	Peak On-State Voltage		I <sub>TM</sub> = 5.5Α, t <sub>P</sub> = 380 μs	Max.	1.55		V	
$V_{GD}$	Q1-Q2-Q3	Non−Trigger Gate Voltage	$V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$ Tj = 150°C	Min.	0.2			V
$V_{GT}$	Q1-Q2-Q3	Gate Trigger Voltage		Max.	1.5			V
I <sub>GT</sub>	Q1-Q2-Q3	Gate Trigger Current	$V_D = 12V$ , $R_L = 33\Omega$	Max.	10	35	50	mA
Ι <sub>Η</sub>	Q1-Q2-Q3	Holding Current	I <sub>T</sub> = 0.1A	Max.	20	45	60	mA
	Q1-Q3	Latching Current	I <sub>G</sub> = 1.2 I <sub>GT</sub>	Max.	20	50	70	mA
١L	Q2				35	70	100	
dV/dt	Critical Rate of Rise of Off-State Voltage		$V_D = 2/3V_{DRM}$ gate open Tj = 150°C	Min.	200	1000	1500	V/µs
(dV/dt)c	Critical Rate of Change of Commutating Voltage		V <sub>D</sub> =400V Tj = 150°C (dl/dt)c=-1.7A/ms	Min.	1	15	20	V/µs
R <sub>th(j-c)</sub>	Junction to case (AC)			Max.	3.0			°C/W
R <sub>th(j-a</sub> )	Junction to ambient(Copper surface under tab:S=0.5cm <sup>2</sup> )			Max.	70			°C/W

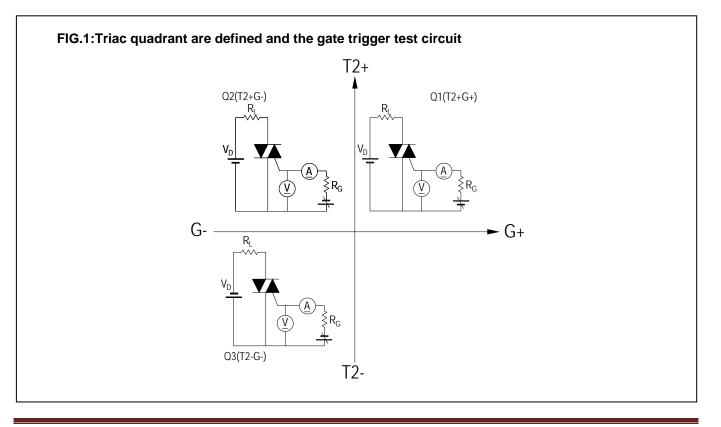




FIG.2: Maximum on-state power dissipation

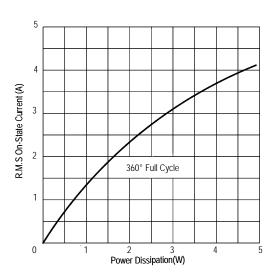


FIG.4: Maximum transient thermal impedance

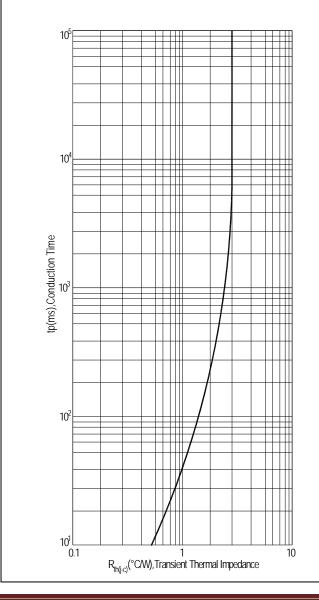
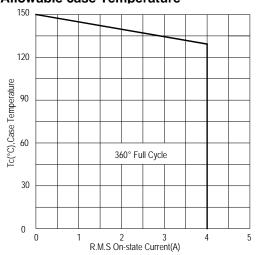


FIG.3: Typical RMS on-state current VS Allowable case Temperature





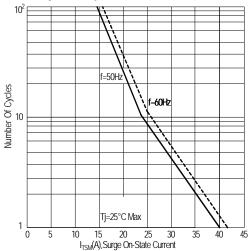
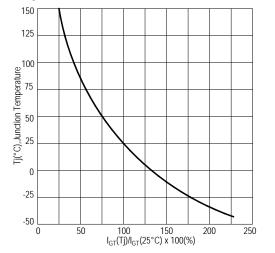
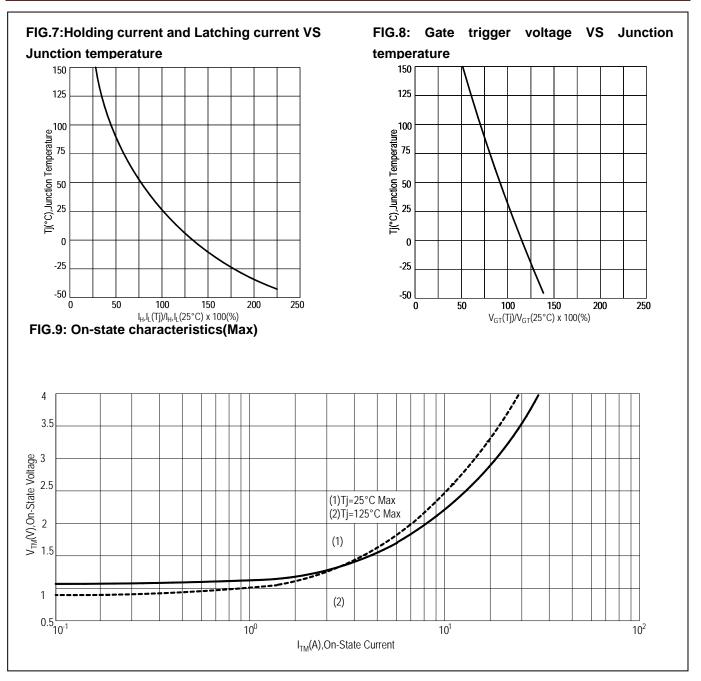


FIG.6: Gate trigger current VS Junction temperature

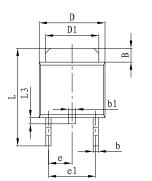


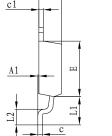


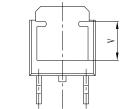
# <u>ADV</u>

# ADT4CH60E/80E

## PACKAGE MECHANICAL DATA TO-252-2 Package Dimension

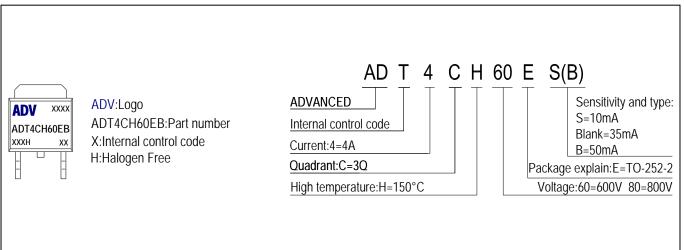






Cumh	Dimer	nsions	Dimensions		
Symb	In Milli	meters	In Inches		
ol	Min.	Max.	Min.	Max.	
А	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
В	1.350	1.650	0.053	0.065	
b	0.500	0.700	0.020	0.028	
b1	0.700	0.900	0.028	0.035	
с	0.450	0.620	0.017	0.024	
c1	0.450	0.620	0.017	0.024	
D	6.350	6.650	0.250	0.262	
D1	5.100	5.400	0.200	0.213	
Е	5.900	6.200	0.232	0.244	
е	2.300 TYP.		0.091 TYP.		
e1	4.500	4.700	0.177	0.185	
L	9.500	10.60	0.374	0.396	
L1	2.550	2.900	0.100	0.114	
L2	1.400	1.780	0.055	0.070	
L3	0.600	0.900	0.024	0.035	
V	4.100 REF.		0.161	0.161 REF.	

#### **Making Diagram**



#### Ordering information

Part number	Package	Marking	Packing	Quantity		
ADT4CH60E#	TO-252-2	ADT4CH60E#	Tube	80pcs		
AD14CH00E#	10-252-2	AD14CH00E#	Embossed tape	2500pcs		
ADT4CH80E#	TO-252-2	ADT4CH80E#	Tube	80pcs		
AD14CHOUE#	10-252-2	AD14CHOUE#	Embossed tape	2500pcs		
Note:# = Gate Trioger Current Sensitivity and type						

Note:# = Gate Trigger Current Sensitivity and type

# ADT4CH60E/80E

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